

## Product Summary

V <sub>BR</sub> (Min)	I <sub>PP</sub> (Max)	C <sub>T</sub> (Typ)
25.4V	3A	11pF

## Features

- 200W Peak Power Dissipation per Line (8/20µs Waveform)
  - Provides ESD Protection per IEC 61000-4-2 Standard: Air ±30kV, Contact ±30kV
  - 2 Channels of ESD Protection
  - Low Channel Input Capacitance
  - **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
  - **Halogen and Antimony Free. "Green" Device (Note 3)**
  - **The DESD1FLEX2SOQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.**
- <https://www.diodes.com/quality/product-definitions/>

## Description and Applications

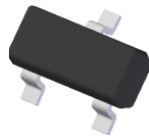
This DESD1FLEX2SOQ is a next generation ESD and surge protection device packaged in a small footprint surface mount package. It is qualified to AEC-Q101, supported by a PPAP and is designed to protect two automotive FlexRay bus lines from ElectroStatic Discharge and other transients.

- FlexRay Bus Protection
- Industrial Control Network

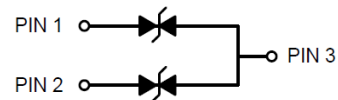
## Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208(Ⓜ3)
- Weight: 0.009 grams (Approximate)

### SOT23



Bottom View



Device Schematic

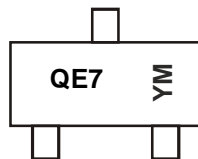
## Ordering Information (Note 4)

Part Number	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
DESD1FLEX2SOQ-7	Automotive	QE7	7	8	3,000/Tape & Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
  2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

## Marking Information

### SOT23



QE7 = Product Type Marking Code  
 YM = Date Code Marking  
 Y = Year (ex: H = 2020)  
 M = Month (ex: 9 = September)

### Date Code Key

Year	2016	...	2020	2021	2022	2023	2024	2025	2026	2027	2028	2029
Code	D	...	H	I	J	K	L	M	N	O	P	R

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

**Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	P <sub>PP</sub>	200	W	8/20μs, per Figure 1
Peak Pulse Current	I <sub>PP</sub>	3	A	8/20μs, per Figure 1
ESD Protection – Contact Discharge	V <sub>ESD_Contact</sub>	±30	kV	IEC 61000-4-2 Standard
ESD Protection – Air Discharge	V <sub>ESD_Air</sub>	±30	kV	IEC 61000-4-2 Standard

**Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	P <sub>D</sub>	300	mW
Thermal Resistance, Junction to Ambient (Note 5)	R <sub>θJA</sub>	417	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

**Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Conditions
Reverse Standoff Voltage	V <sub>RWM</sub>	—	—	24	V	—
Channel Leakage Current (Note 6)	I <sub>RM</sub>	—	<1	50	nA	V <sub>RWM</sub> = 24V
Clamping Voltage, Positive Transients	V <sub>CL</sub>	—	—	40	V	I <sub>PP</sub> = 1A, t <sub>p</sub> = 8/20μs, Figure 1
		—	—	70		I <sub>PP</sub> = 3A, t <sub>p</sub> = 8/20μs, Figure 1
Breakdown Voltage	V <sub>BR</sub>	25.4	27.8	30.3	V	I <sub>R</sub> = 1mA
Channel Input Capacitance	C <sub>T</sub>	—	11	17	pF	V <sub>R</sub> = 0V, f = 5MHz
		—	—	17		
ABS Parasitic Capacitance Matching (Channel 1 – Channel 2)	Δ (C <sub>T_Ch1</sub> -C <sub>T_Ch2</sub> ) / C <sub>T_Max</sub>	—	0.12	2	%	V <sub>R</sub> = 5V, f = 5MHz
	Δ (C <sub>T_Ch1</sub> -C <sub>T_Ch2</sub> )	—	0.02	0.34	pF	

- Notes:
- Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes Incorporated's suggested pad layout, which can be found on our website at <http://www.diodes.com/package-outlines.html>.
  - Short duration pulse test used to minimize self-heating effect.

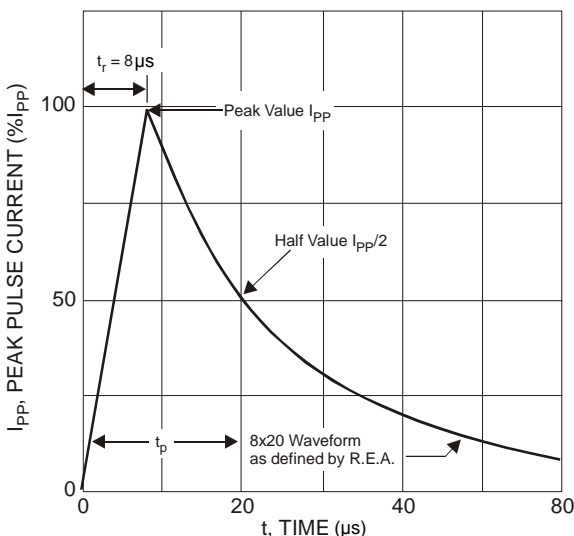
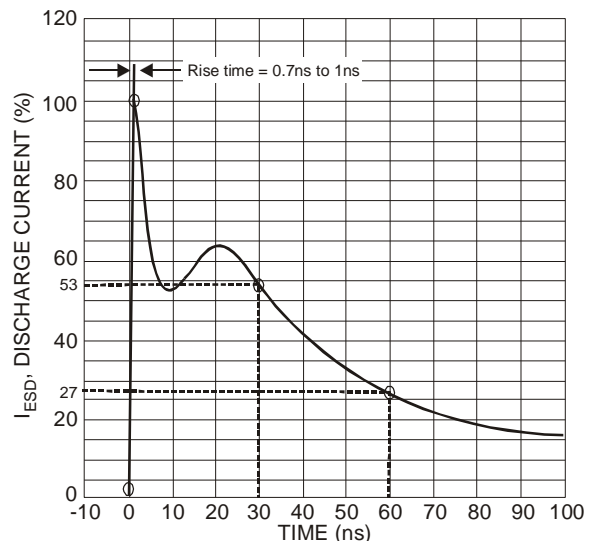


Figure 1 Pulse Waveform


 Figure 2 ESD Discharge Current Wave Form  
IEC 61000-4-2 (330Ω/150pF)

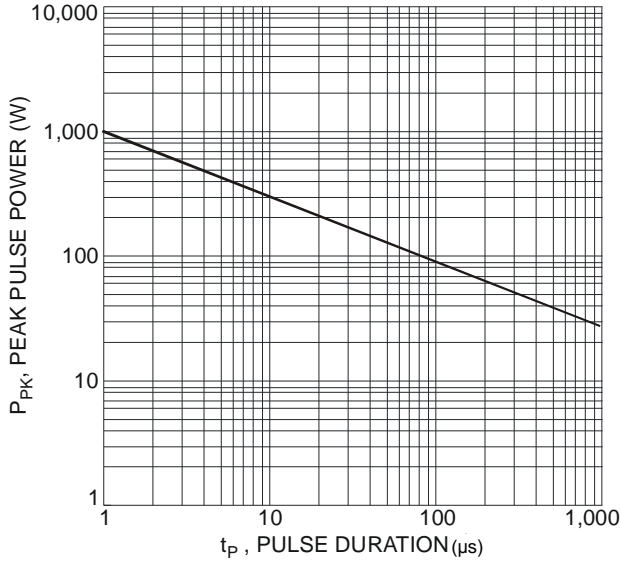


Figure 3 Peak Pulse Power vs. Pulse Duration

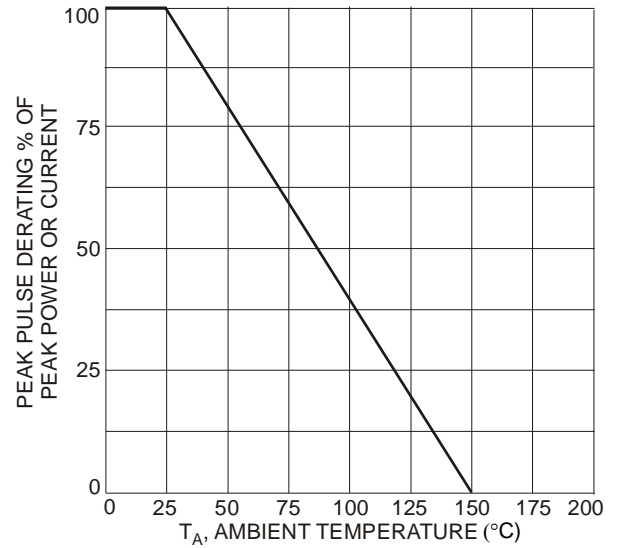


Figure 4 Pulse Derating Curve

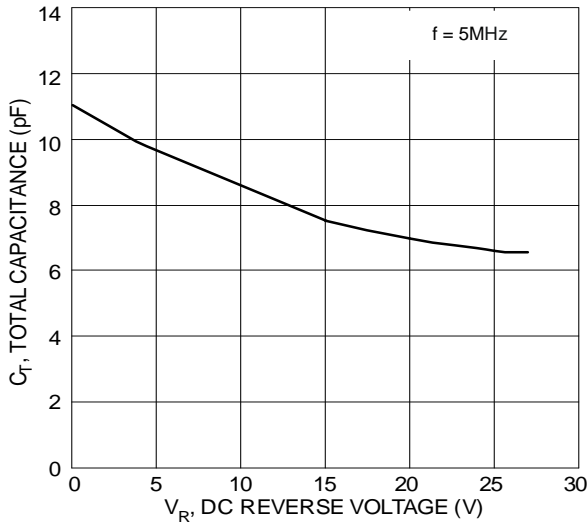


Figure 5 Total Capacitance vs. Reverse Voltage

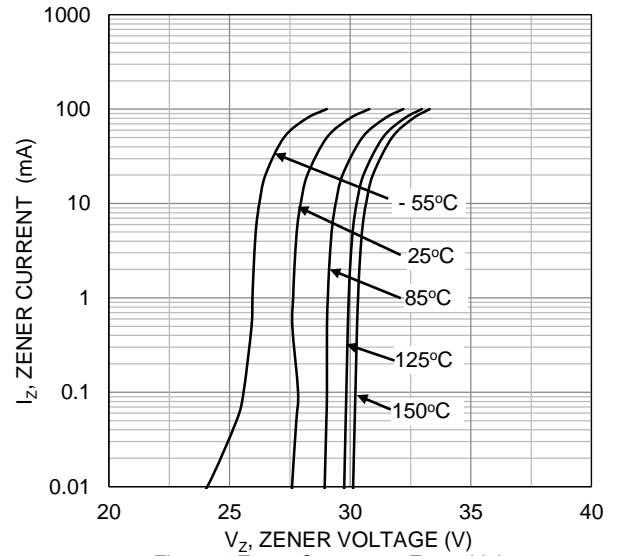


Figure 6 Zener Current vs. Zener Voltage

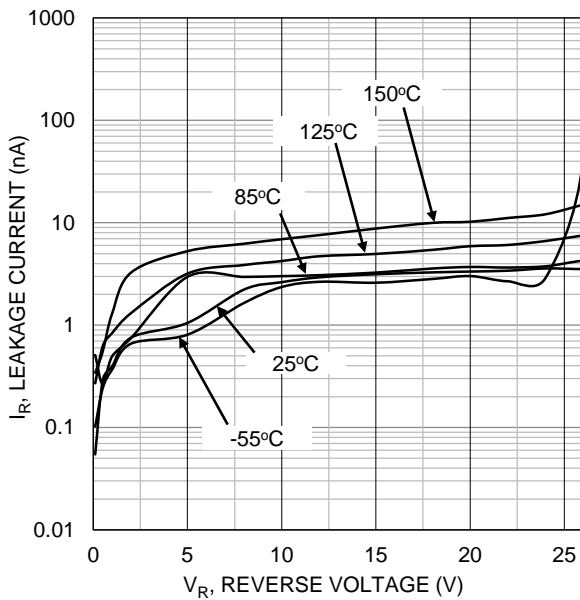
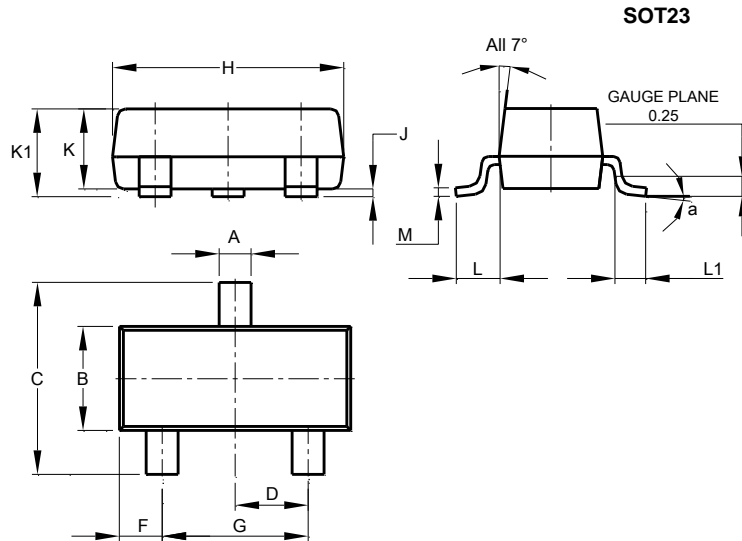


Figure 7  $I_R$  vs.  $V_R$  Temperature Characteristic

**Package Outline Dimensions**

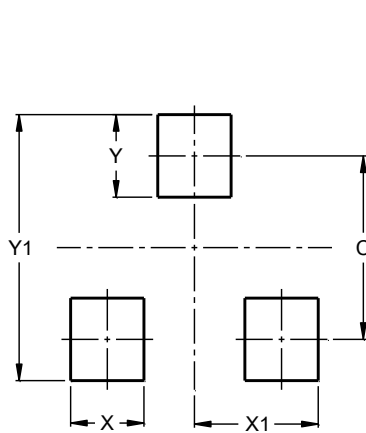
Please see <http://www.diodes.com/package-outlines.html> for the latest version.



SOT23			
Dim	Min	Max	Typ
A	0.37	0.51	0.40
B	1.20	1.40	1.30
C	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
H	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.890	1.00	0.975
K1	0.903	1.10	1.025
L	0.45	0.61	0.55
L1	0.25	0.55	0.40
M	0.085	0.150	0.110
a	0°	8°	--
All Dimensions in mm			

**Suggested Pad Layout**

Please see <http://www.diodes.com/package-outlines.html> for the latest version.



Dimensions	Value (in mm)
C	2.0
X	0.8
X1	1.35
Y	0.9
Y1	2.9

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